

Manual Update Sheet

DATE: June 1, 1998

Document Being Updated: *TMS320C3x/C4x Assembly Language Tools User's Guide*

Literature Number Being Updated: SPRU035C

Manual Included in a Kit: No

This Manual Update Sheet (SPRZ131) ships with the *TMS320C3x/C4x Assembly Language Tools User's Guide*.

Updates within paragraphs appear in a **bold typeface**.

Page: **Change or Add:**

- 3-6 Include two suboptions in the -v option description.
 - v specifies a version. The version tells the assembler which of the following TMS320C3x/C4x devices it should produce code for (The default is -v30):
 - v30 selects the TMS320C30
 - v31 selects the TMS320C31
 - v32 selects the TMS320C32
 - v40 selects the TMS320C40
 - v44 selects the TMS320C44
 - msrevx the x = 1,2,3, etc.
 - specifies the silicon revision of the target chip to enable additional functionality for more recent silicon releases. Used in conjunction with -v flag.
 - Example:
 - msrev6 -v31 : enable new (1996) 'C31 parallel instructions
 - msrev2 -v32 : enable new (1996) 'C32 parallel instructions

- B-10 Change the fifth bullet.
 - Size is the number of **bits** of memory required to contain this variable.

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